

NTE2974 MOSFET N-Channel, Enhancement Mode High Speed Switch

Features:

- Low On-State Resistance: $R_{DS(on)} = 1.1\Omega$ Max ($V_{GS} = 10V$, $I_D = 3A$)
- Low Input Capacitance: $C_{iss} = 1150pF$ Typ
- High Avalanche Capability Ratings
- Isolated TO220 Type Package

Absolute Maximum Ratings: ($T_A = +25^\circ C$ unless otherwise specified)

Drain-to-Source Voltage, V_{DSS}	600V
Gate-to-Source Voltage, V_{GSS}	$\pm 30V$
Drain Current, I_D	
DC	$\pm 6.0A$
Pulse (Note 1)	$\pm 24A$
Total Power Dissipation, P_T	
$T_C = +25^\circ C$	35W
$T_A = +25^\circ C$	2.0W
Single Avalanche Current (Note 2), I_{AS}	6.0A
Single Avalanche Energy (Note 2), E_{AS}	12mJ
Channel Temperature, T_{ch}	$+150^\circ C$
Storage Temperature Range, T_{stg}	-55° to $+150^\circ C$

Note 1. $PW \leq 10\mu s$, Duty Cycle $\leq 1\%$.

Note 2. Starting $T_{ch} = +25^\circ C$, $R_G = 25\Omega$, $V_{GS} = 20V \rightarrow 0$.

Electrical Characteristics: ($T_A = +25^\circ C$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10V$, $I_D = 3A$	—	0.8	1.1	Ω
Gate-to-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 10V$, $I_D = 1mA$	2.5	—	3.5	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS} = 10V$, $I_D = 3A$	2.0	—	—	S
Drain Leakage Current	I_{DSS}	$V_{DS} = 600V$, $V_{GS} = 0$	—	—	100	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 30V$, $V_{DS} = 0$	—	—	± 100	nA

Electrical Characteristics (Cont'd): ($T_A = +25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0, f = 1MHz	–	1150	–	pF
Output Capacitance	C _{oss}		–	260	–	pF
Reverse Transfer Capacitance	C _{rss}		–	60	–	pF
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DD} = 150V, I _D = 3A, R _G = 10Ω, R _L = 37.5Ω	–	15	–	ns
Rise Time	t _r		–	15	–	ns
Turn-Off Delay Time	t _{d(off)}		–	75	–	ns
Fall Time	t _f		–	13	–	ns
Total Gate Charge	Q _G	V _{GS} = 10V, I _D = 6A, V _{DD} = 480V	–	40	–	nC
Gate-to-Source Charge	Q _{GS}		–	6	–	nC
Gate-to-Drain Charge	Q _{GD}		–	20	–	nC
Diode Forward Voltage	V _{F(S–D)}	I _F = 6A, V _{GS} = 0	–	1.0	–	V
Reverse Recovery Time	t _{rr}	I _F = 6A, di/dt = 50A/μs	–	370	–	ns
Reverse Recovery Charge	Q _{rr}		–	1.5	–	μC

